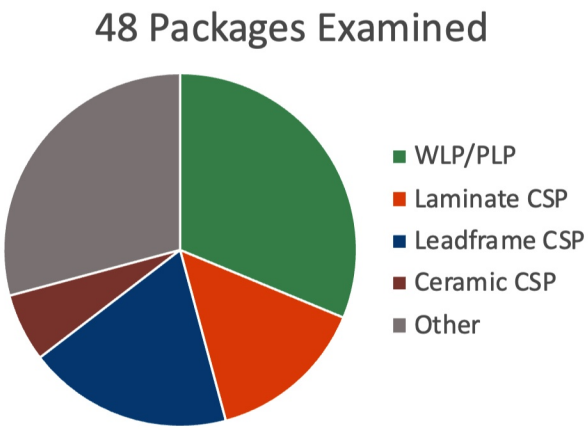
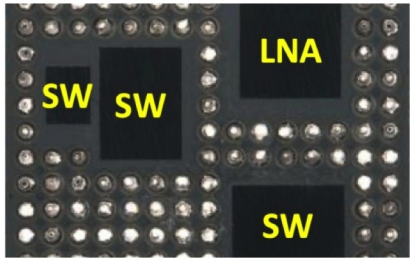
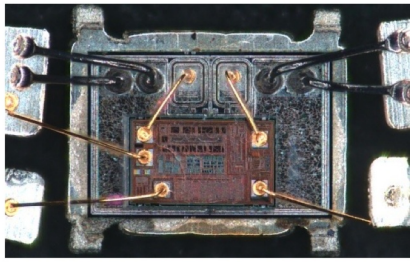
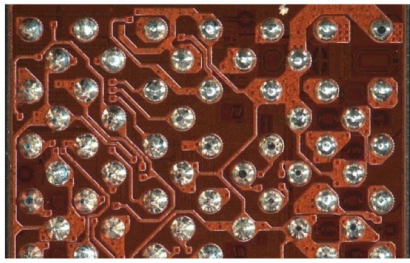
Samsung Galaxy Watch5 (Wi-Fi + LTE)

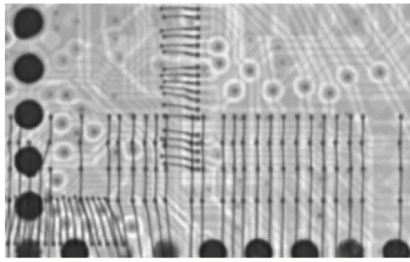
Teardown from TechSearch International, Inc.

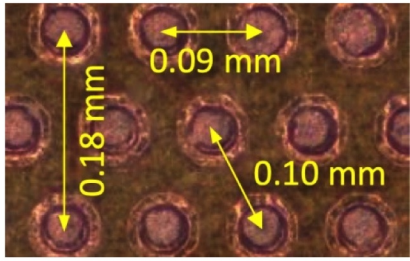


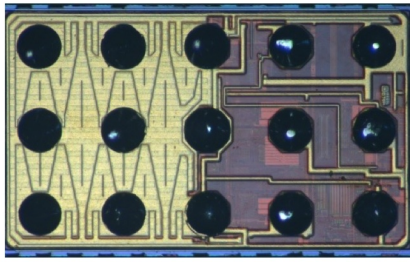












Contents and Highlights

- 72-page report with chip package photo, x-rays, and measurements
- 11 additional slides with details about the Samsung Exynos W920 mobile processor in a two-die fan-out PLP, two Qualcomm 5G RF modules, Samsung Exynos RF 6550 Wi-Fi/Bluetooth SoC, ConvenientPower wireless power receiver, Halo programmable DVS buck converter, and Melexis infrared temperature sensor

Teardowns backed by 36 years serving as the industry's trusted source for semiconductor packaging trend analysis

- Examination of all chips with emphasis on assembly and packaging technologies
- Superb quality photographs and x-ray images
- Both the packages and the die within are identified and characterized
- Detailed construction analysis of key chips and packages

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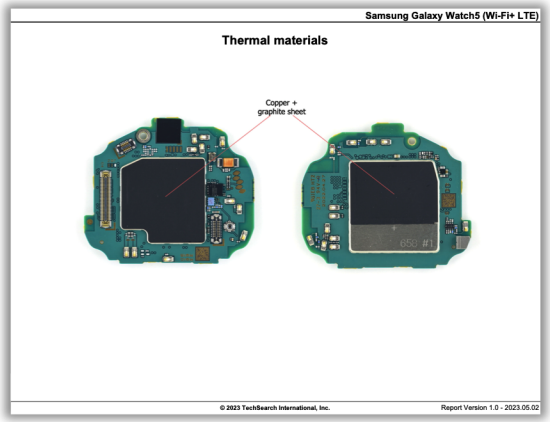
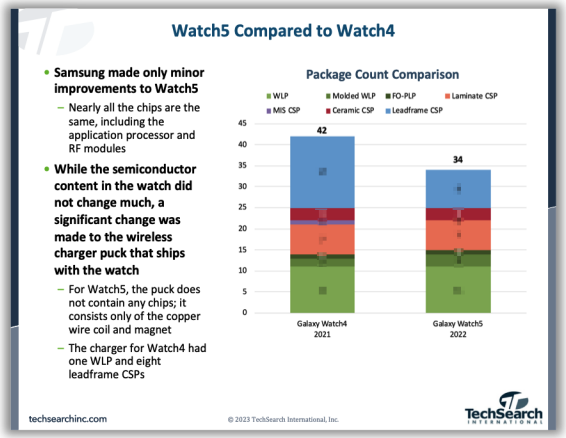
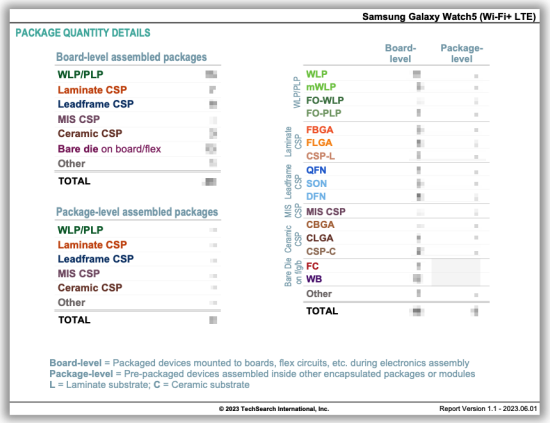
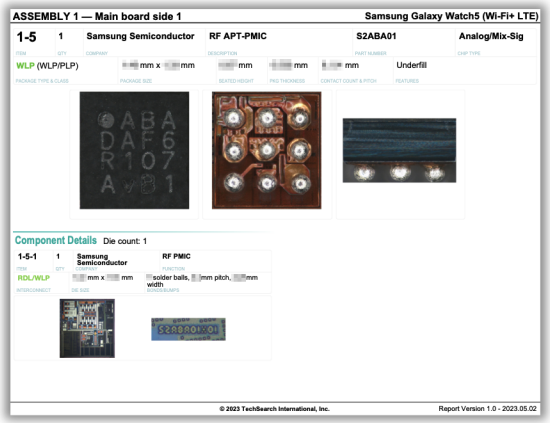
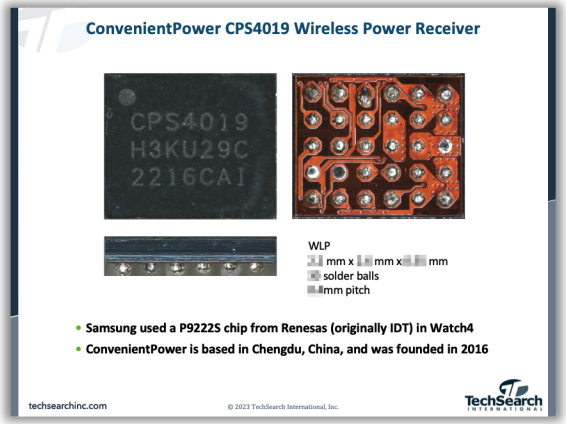
Sample pages from the report and slides

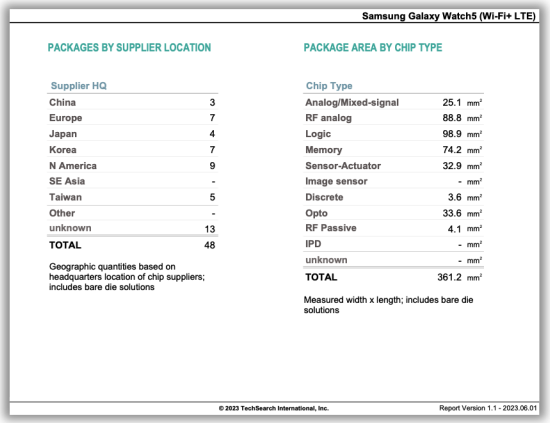


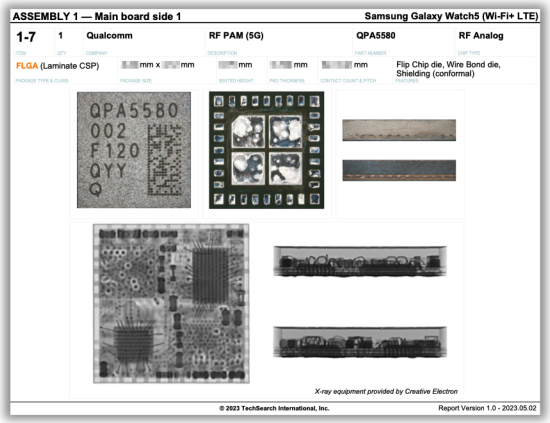


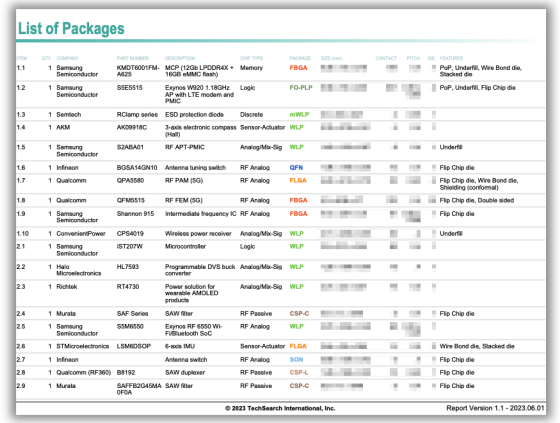












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